

Dual N-channel MOSFET (common drain)

ELM18820BA-S

■ General description

ELM18820BA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and operation with gate voltages as low as 1.8V and internal ESD protection.

■ Features

- $V_{ds}=20V$
- $I_d=7A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 21m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 24m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} < 32m\Omega$ ($V_{gs}=2.5V$)
- $R_{ds(on)} < 50m\Omega$ ($V_{gs}=1.8V$)
- ESD Rating : 2000V HBM

■ Maximum absolute ratings

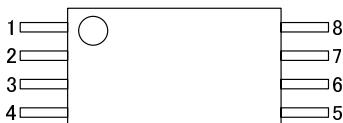
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	20	V	
Gate-source voltage	V_{gs}	± 12	V	
Continuous drain current Ta=25°C	I_d	7.0	A	1
Ta=70°C		5.5		
Pulsed drain current	I_{dm}	25	A	2
Power dissipation Ta=25°C	P_d	1.50	W	1
Ta=70°C		0.96		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	$R_{\theta ja}$	64	83	°C/W	1
Maximum junction-to-ambient	Steady-state		89	120	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	53	70	°C/W	3

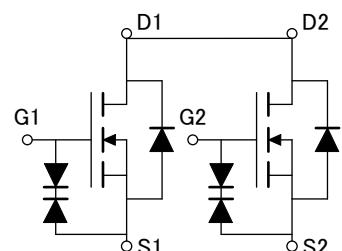
■ Pin configuration

TSSOP-8 (TOP VIEW)



Pin No.	Pin name
1	DRAIN1/DRAIN2
2	SOURCE1
3	SOURCE1
4	GATE1
5	GATE2
6	SOURCE2
7	SOURCE2
8	DRAIN1/DRAIN2

■ Circuit



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■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	$I_d=250\mu A$, $V_{gs}=0V$	20			V
Zero gate voltage drain current	Idss	$V_{ds}=16V$			1	μA
		$V_{gs}=0V$	$T_j=55^\circ C$		5	μA
Gate-body leakage current	Igss	$V_{ds}=0V$, $V_{gs}=\pm 10V$			10	μA
Gate-source breakdown voltage	BVgso	$V_{ds}=0V$, $I_g=\pm 250\mu A$	± 12			V
Gate threshold voltage	Vgs(th)	$V_{ds}=V_{gs}$, $I_d=250\mu A$	0.50	0.65	1.00	V
On state drain current	$I_d(on)$	$V_{gs}=4.5V$, $V_{ds}=5V$	25			A
Static drain-source on-resistance	Rds(on)	$V_{gs}=10V$		16.5	21.0	$m\Omega$
		$I_d=7A$	$T_j=125^\circ C$	23.1		$m\Omega$
		$V_{gs}=4.5V$, $I_d=6.6A$		19.0	24.0	$m\Omega$
		$V_{gs}=2.5V$, $I_d=5.5A$		25.0	32.0	$m\Omega$
		$V_{gs}=1.8V$, $I_d=2A$		35.0	50.0	$m\Omega$
Forward transconductance	Gfs	$V_{ds}=5V$, $I_d=7A$		25		S
Diode forward voltage	Vsd	$I_s=1A$, $V_{gs}=0V$		0.75	1.00	V
Max. body-diode continuous current	Is			2.5		A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	$V_{gs}=0V$, $V_{ds}=10V$, $f=1MHz$		615		pF
Output capacitance	Coss			150		pF
Reverse transfer capacitance	Crss			120		pF
Gate resistance	Rg	$V_{gs}=0V$, $V_{ds}=0V$, $f=1MHz$		0.9		Ω
SWITCHING PARAMETERS						
Total gate charge	Qg	$V_{gs}=4.5V$, $V_{ds}=10V$, $I_d=7A$		8.5	12.0	nC
Gate-source charge	Qgs			1.2		nC
Gate-drain charge	Qgd			3.0		nC
Turn-on delay time	td(on)	$V_{gs}=5V$, $V_{ds}=10V$ $R_L=1.4\Omega$, $R_{gen}=3\Omega$		7		ns
Turn-on rise time	tr			13		ns
Turn-off delay time	td(off)			29		ns
Turn-off fall time	tf			11		ns
Body diode reverse recovery time	trr	$I_f=7A$, $dl/dt=100A/\mu s$		15		ns
Body diode reverse recovery charge	Qrr	$I_f=7A$, $dl/dt=100A/\mu s$		5		nC

NOTE :

1. The value of $R_{\theta ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta ja}$ is the sum of the thermal impedance from junction to lead $R_{\theta jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.

■ Typical electrical and thermal characteristics

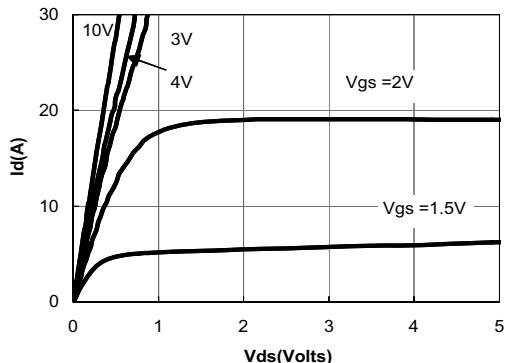


Figure 1: On-Regions Characteristics

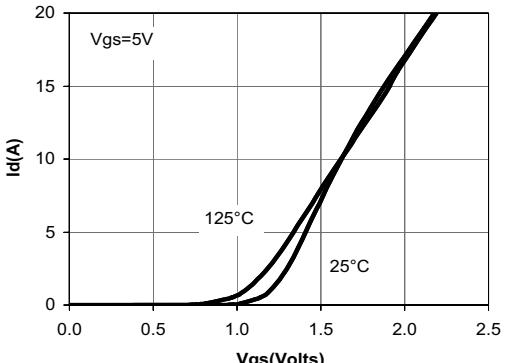


Figure 2: Transfer Characteristics

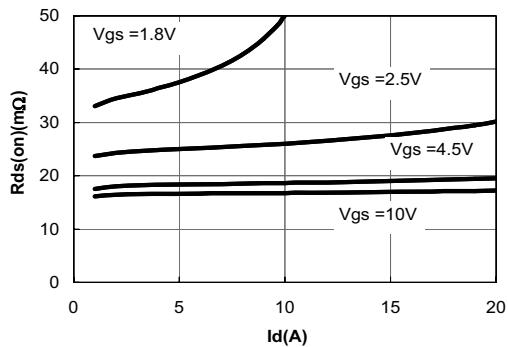


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

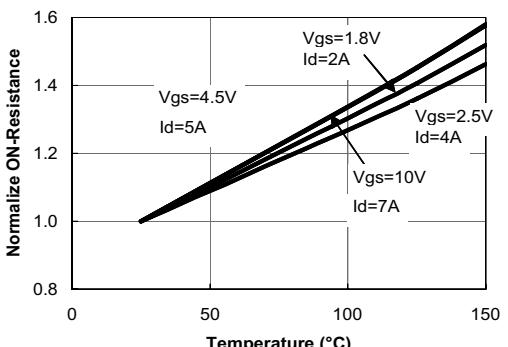


Figure 4: On-Resistance vs. Junction Temperature

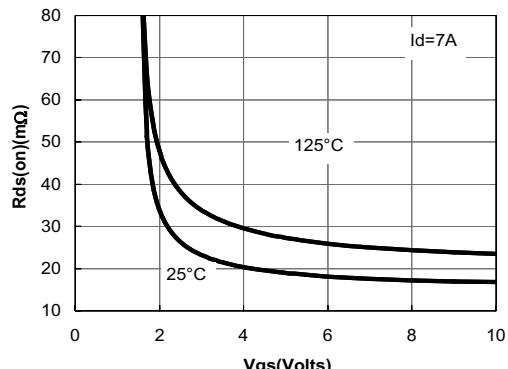


Figure 5: On-Resistance vs. Gate-Source Voltage

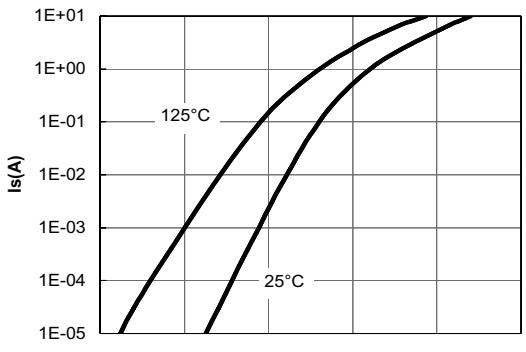


Figure 6: Body-Diode Characteristics

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